RECORDATION FO	RM COVER SHEET	
PATENTS ONLY To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below		
KAZUYA SUZUKI (01/30/2006), HAJIME NISHIMURA (01/30/2006), TETSUYA TAMURA (01/30/2006), AND TAKESHI SASA	2 Name and address of receiving party(les)	
(01/30/2006)	Name: SONY CORPORATION	
Execution Date(s): in parentheses after inventor name	Internal Address:	
Additional name(s) of conveying party(ies) attached? Yes X No	Street Address: I-7-1 Konan, Minato-ku	
3. Nature of Conveyance;		
X Assignment Merger		
Security Agreement Change of Name	City:	
Government Interest Assignment	State:	
Executive Order 9424, Confirmatory License	Country: JAPAN Zip: 108-0075	
Other	Additional name(s) & address(es) Yes X No	
11/368,833		
Additional numbers attached?	Yes X No	
	6. Total number of applications and patents involved:	
LERNER, DAVID, LITTENBERG,	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00	
emal Address: Atty. Dkt.; SONYJP 3.0-547	Authorized to be charged by credit card	
eet Address: 600 South Avenue West		
	Authorized to be charged to deposit account	
1	Enclosed	
. Westfield	None required (government interest not affecting title)	
	. Payment Information	
ne Number: (908) 518-6316	a. Credit Card Last 4 Numbers	
Number: (908) 654 0445	Expiration Date	
all Address: nmorelli@ldlkm.com	b. Deposit Account Number 12-1095	
gnature: 6)/Ce XI Oo r	Authorized User Name Natalie S. Morelli	
Signature	May 13, 2009	
Natalie S. Morelli - 58,545	Total number of pages including cover	

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PATENT REEL: 022683 FRAME: 0711

S06P0251US00

Docket Number:	SONYJP	3.0-547
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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in COMPOSITE MEMORY DEVICE, DATA PROCESSING METHOD AND DATA PROCESSING PROCESSING

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: <u>11/368,833</u>, Filing Date: March 6, 2006.

This assignment executed on the dates indicated below.

Kazuya SUZUKI	ζŤ . .
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor	
ignature of fifst of sole inventor	January 30, 2006
-2 margine of first of 2015 Inventor	Date of this assignment

PATENT REEL: 022683 FRAME: 0712

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Execution date of U.S. Patent Application
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Date of this assignment
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January 310 2006
Execution date of U.S. Patent Application
Old. I atom Application
January 30 2001
January 3D, 2008 Date of this assignment
January 30, 2006
Execution date of U.S. Patent Application
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PATENT REEL: 022683 FRAME: 0713

RECORDED: 05/14/2009